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# EMERGENCY PHONE 1-800-255-3924 TECHNICAL DATA SHEETS MP 5405 BK

## **Description:**

**MP 5405 BLACK** is a two part unfilled epoxy adhesive designed for ceramics, and most plastics. It cures to a tough semi-rigid material, and is free flowing in viscosity. It gives good resistance to water, salt spray, inorganic acids and bases, and most organic solvents. It was especially formulated to a 1:1 mix ratio for use in either MMD equipment or side-by-side dual cartridges for easy dispensing.

A handling cure is normally achieved at room temperature within 20 - 30 minutes with full cure in 24 hours. An elevated temperature cure schedule can be used to reach final properties quickly.

#### Handling and Storage:

1) Bring both components to room temperature prior to mixing. Mix 1 parts A to 1 part B thoroughly.

2) Allow to cure undisturbed until product is fully gelled or tack-free to the touch.

3) Clean up uncured resin with suitable organic solvent such as MEK, acetone or a chlorinated.solvent.

#### **Mix Ratio:**

1A:1B by weight or 1A:1B by volume.

Shelf Life: 12 Months

## Handling Characteristics:

All properties given are at 25C unless otherwise noted.

Color	Black	
Viscosity	Part A Part B Mixed	14,000 cps 15,000 cps 14,500 cps
Specific Gravity	Part A Part B Mixed	1.16 1.15 1.16
Pot Life Mass	3 - 5 minutes 20 grams	
Tensile Strength Lap Shear (Al to Al) Tensile Elongation Tensile Strength Temperature Range	2300 psi 3 - 5% 7000 psi -40 to 130C	
Hardness Method	80 Shore -D	
Linear Coefficient of Thermal Expansion (x 10 (6))/C 62		
Dielectric Constant (25C, 100Hz)	4.5	
Dielectric Strength	410 v/mil	
Volume Resistivity	8 x 10 <sup>14</sup> ohm-cm	

# Engineering Excellence

For technical information and support call **1-800-552-0299** or visit our website at

